



## Surface Mount Ultra Fast Recovery Rectifier

### Features

- Low profile package
- Ideal for automated placement
- Guardring for overvoltage protection
- Low power losses, high efficiency
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

### Typical Applications

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

### Mechanical Date

**Package:** SOD-123HE

Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant, halogen-free

**Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102

**Polarity:** Cathode line denotes the cathode end

### Maximum Ratings (T<sub>a</sub>=25 Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	U1AE	U1BE	U1CE	U1DE	U1FE	U1GE	U1HE	U1JE
Device marking code			U1AE	U1BE	U1CE	U1DE	U1FE	U1GE	U1HE	U1JE
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	V	50	100	150	200	300	400	500	600
Maximum RMS Voltage	V <sub>RMS</sub>	V	35	70	105	140	210	280	350	420
Maximum DC blocking Voltage	V <sub>DC</sub>	V	50	100	150	200	300	400	500	600
Average rectified output current @60Hz sine wave, Resistance load, TL (FIG.1)	I <sub>O</sub>	A	1.0							
Forward Surge Current (Non-repetitive) @60Hz Half-sine wave, 1 cycle, T <sub>j</sub> =25	I <sub>FSM</sub>	A	30							
Forward Surge Current (Non-repetitive) @1ms, square wave, 1 cycle, T <sub>j</sub> =25			60							
Current squared time @1ms t 8.3ms T <sub>j</sub> =25	I <sup>2</sup> t	A <sup>2</sup> s	3.735							
Storage temperature	T <sub>stg</sub>	-	-55 ~ +150							
Junction temperature	T <sub>j</sub>									



## U1AE THRU U1JE

### Electrical Characteristics ( $T_a=25$ Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	U1AE	U1BE	U1CE	U1DE	U1FE	U1GE	U1HE	U1JE
Maximum instantaneous forward voltage	$V_F$	V	$I_{FM}=1.0A$			0.92		1.25			1.7



# U1AE THRU U1JE

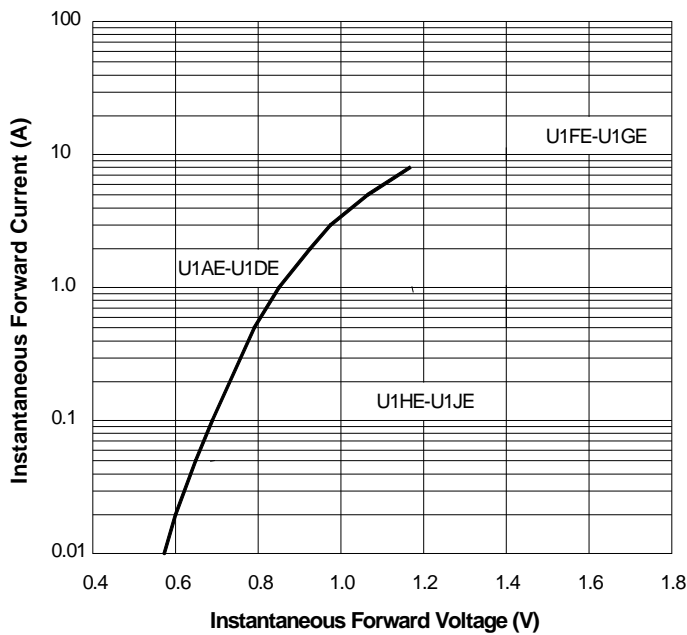
## Thermal Characteristics ( $T_a=25$ Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	U1AE	U1BE	U1CE	U1DE	U1FE	U1GE	U1HE	U1JE
Typical Thermal resistance	R J-A <sup>(1)</sup>	/W	65							
	R J-L <sup>(1)</sup>		25							
	R J-C <sup>(1)</sup>		20							

Note:  
 (1) Thermal resistance between junction and ambient and between junction and lead mounted on P.C.B with 3mm\*3mm copper pad areas.

## Characteristics (Typical)

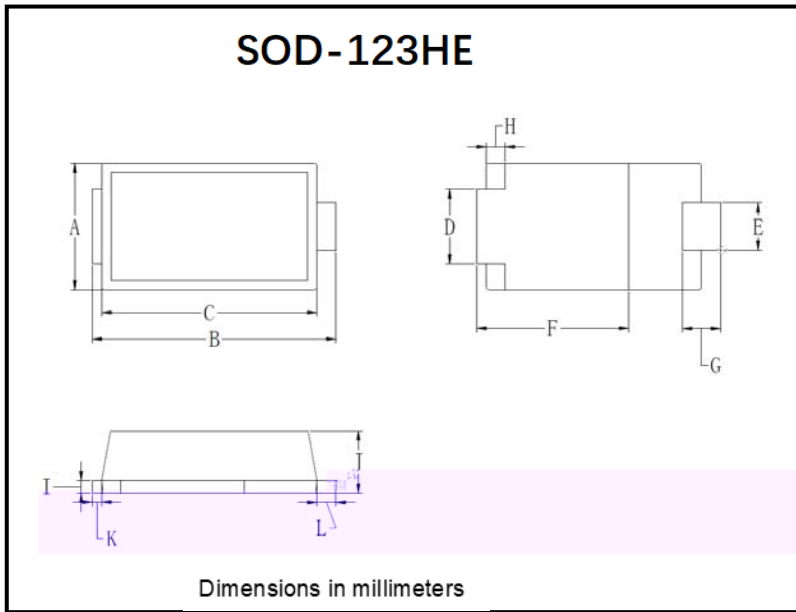
FIG.3: Typical Forward Characteristics





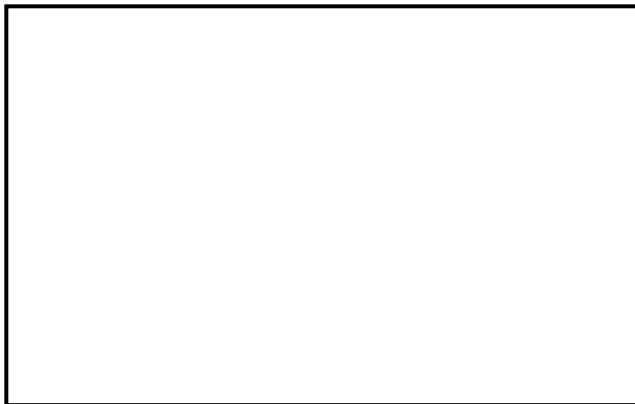
# U1AE THRU U1JE

## Outline Dimensions



SOD-123HE		
Dim	Min	Max
A	1.88	2.18
B	3.70	4.00
C	3.19	3.61
D	1.05	1.35
E	0.61	0.91
F	2.20	2.90
G	0.40	0.80
H	0.30 TYP	
I	0.10	0.30
J	0.85	1.15
K	0.00	0.30
L	0.15	0.45

## Suggested pad layout



SOD-123HE	
Dim	Millimeters
P1	0.64
Q1	2.54
Q2	2.67
Q3	1.27
Q4	0.76



## Disclaimer

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